

# TPS61021A-PWR723 Evaluation Module

This user's guide describes the characteristics, operation, and the use of the TPS61021EVM-723 evaluation module (EVM). The EVM contains the TPS61021A, which is a 3-A boost converter with 0.5-V ultra-low input voltage. This user's guide includes EVM specifications, recommended test setup, test results, a schematic diagram, bill of materials (BOM), and the board layout.

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#### 1 Introduction

### 1.1 Performance Specification

Table 1 provides a summary of the TPS61021A EVM performance specifications. All the specifications are given for an ambient temperature of 25°C.

Specification	Test Conditions	MIN	ТҮР	MAX	Unit
Input voltage		0.9	2.4	3.2	V
Output voltage	TPS61021A EVM, $V_{IN} = 2.4$ V, $I_O \le 2$ A	3.2	3.3	3.4	V
Output current	$V_{IN} = 1.2 V$			1	А
	V <sub>IN</sub> = 2.4 V			2.3	А

#### **Table 1. Performance Specification Summary**

### 1.2 Modification

The printed-circuit board (PCB) for this EVM is designed to accommodate some modifications by the user. The external component can be changed according to the real application.

### 1.3 Input Capacitor

A 150- $\mu$ F tantalum capacitor, C1, is added as the input capacitor in the EVM. The ESR of the tantalum capacitor is 0.1  $\Omega$ , to damp the ringing of the input voltage when the EVM is powered by a power supply with a long cable. The capacitor is not required for proper operation and can be removed in a real application.

### 1.4 Feedforward Capacitor

A feedforward capacitor, C7 in Figure 7, is used to improve the phase margin of the boost converter. Equation 1 calculates the zero frequency formed by the feedforward capacitor C7, and the resistor R1 of the feedback resistor divider.

$$f_{z} = \frac{1}{2\pi \times \text{R1} \times \text{C7}}$$
(1)

TI recommends setting  $f_z$  at 50 kHz to boost the phase margin at the crossover frequency. When R1 = 316 k $\Omega$ , C7 is 10 pF on the EVM.

### 2 Setup

This section describes how to properly connect, set up, and use the TPS61021EVM-723.

### 2.1 Input/Output Connector Descriptions

The following :

J1-VIN	Positive input connection from the input supply for the EVM
J2-GND	Return connection from the input supply for the EVM
J5-VOUT	Positive connection for the output voltage
J6-GND	Return connection for the output voltage
J7-EN	EN pin input jumper. Place a jumper across EN and pin 1 to turn on the IC, place a jumper across EN and pin 3 to turn off the IC



### 3 Test Results

## 3.1 Startup Waveform

The startup waveform is shown in Figure 1.

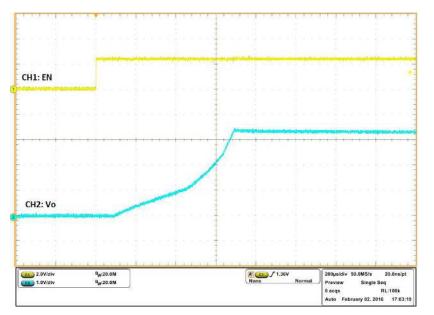


Figure 1. Startup Waveforms (No Load)

### 3.2 Efficiency

The conversion efficiency is shown in Figure 2.

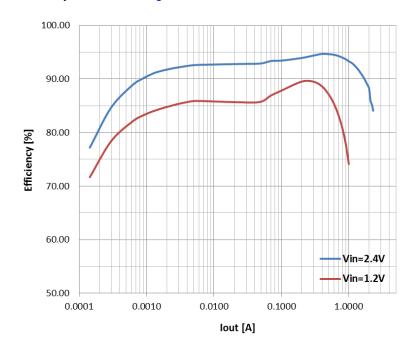


Figure 2. TPS61021A EVM Efficiency vs Load Current

Test Results



Test Results

### 3.3 Load Transient

The load transient waveform is shown in Figure 3. Note that the effective output capacitance is about 31  $\mu$ F under V<sub>o</sub> = 3.3 V DC bias, although two 22- $\mu$ F ceramic capacitors are used in the EVM. Larger effective capacitance helps to improve the load transient.

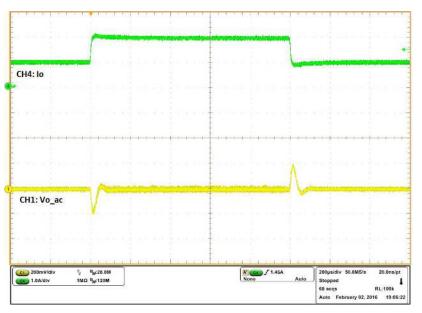
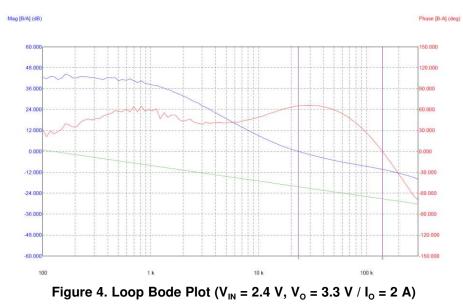


Figure 3. Load Transient ( $V_o = 3.3 V$ ,  $I_o = 1 A$  to 2 A)

### 3.4 Loop Characteristics

The loop Bode plot is shown in Figure 4.





# 3.5 Output Voltage Ripple

Figure 5 shows the output voltage ripple , switching waveforms, and the inductor current ripple in CCM mode.

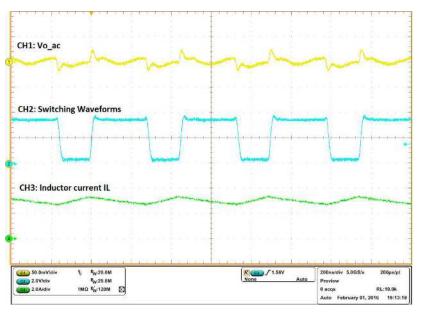


Figure 5. Output Ripple in CCM (V<sub>IN</sub> = 2.4 V, V<sub>0</sub> = 3.3 V / I<sub>0</sub> = 2 A)

Figure 6 shows the output voltage ripple, switching waveforms, and the inductor current ripple in PFM mode when the converter is operating at light load.

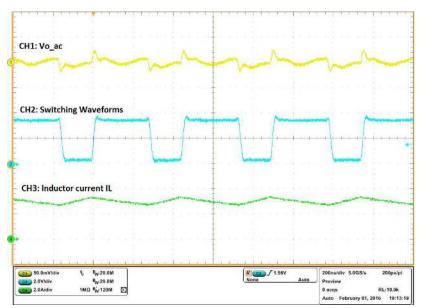


Figure 6. Output Ripple in PFM (V<sub>IN</sub> = 2.4 V, V<sub>o</sub> = 3.3 V / I<sub>o</sub> = 160 mA)



#### Schematic and Bill of Materials

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# 4 Schematic and Bill of Materials

This section provides the TPS61021EVM-723 schematic, bill of materials (BOM), and board layout.

### 4.1 Schematic

Figure 7 illustrates the EVM schematic.

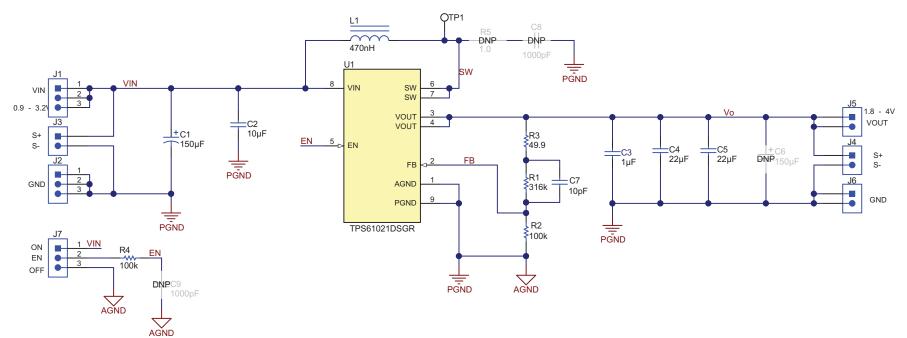


Figure 7. TPS61021EVM-723 Schematic



# 4.2 Bill of Materials

 Table 2 displays the EVM bill of materials.

Table 2. TPS61021EVM-723 Bill of Mate	erials
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Designator	QTY	Value	Description	Package	Part Number	MFG
C1	1	150uF	CAP, TA, 150 µF, 10 V, +/- 10%, 0.1 ohm, SMD	7343-31	T495D157K010ATE100	Kemet
C2	1	10uF	CAP, CERM, 10 µF, 6.3 V, +/- 20%, X5R, 0603	0603	GRM188R60J106ME47D	MuRata
C3	1	1uF	CAP, CERM, 1 µF, 25 V, +/- 10%, X7R, 0603	0603	GRM188R71E105KA12D	MuRata
C4, C5	2	22uF	CAP, CERM, 22 µF, 10 V, +/- 20%, X5R, 0805	0805	GRM21BR61A226ME44L	MuRata
C7	1	10pF	CAP, CERM, 10 pF, 100 V, +/- 5%, C0G/NP0, 0603	0603	GRM1885C2A100JA01D	MuRata
J1, J2, J7	3		Header, 100mil, 3x1, Gold, TH	3x1 Header	TSW-103-07-G-S	Samtec
J3, J4, J5, J6	4		Header, 100mil, 2x1, Gold, TH	2x1 Header	TSW-102-07-G-S	Samtec
L1	1	470nH	Inductor, Shielded, Composite, 470 nH, 3.5 A, 0.0076 ohm, SMD	SMD, 4x4x1.5mm	XFL4015-471MEC	Coilcraft
R1	1	316k	RES, 316 k, 1%, 0.1 W, 0603	0603	RC0603FR-07316KL	Yageo America
R2, R4	2	100k	RES, 100 k, 1%, 0.1 W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale
R3	1	49.9	RES, 49.9, 1%, 0.1 W, 0603	0603	RC0603FR-0749R9L	Yageo America
U1	1		3-A BOOST CONVERTER WITH 0.5V ULTRA-LOW INPUT VOLTAGE, DSG0008A	DSG0008A	TPS61021ADSGR	Texas Instruments
C6	0	150uF	CAP, TA, 150 µF, 10 V, +/- 10%, 0.1 ohm, SMD	7343-31	T495D157K010ATE100	Kemet
C8, C9	0	1000pF	CAP, CERM, 1000 pF, 50 V, +/- 10%, X7R, 0603	0603	C0603C102K5RACTU	Kemet
R5	0	1.0	RES, 1.0, 5%, 0.1 W, 0603	0603	CRCW06031R00JNEA	Vishay-Dale



### 5 Board Layout

Figure 8 and Figure 9 show the design of the TPS61021EVM-723 PCB layout.

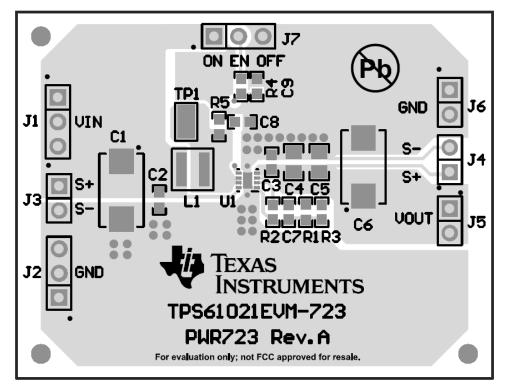
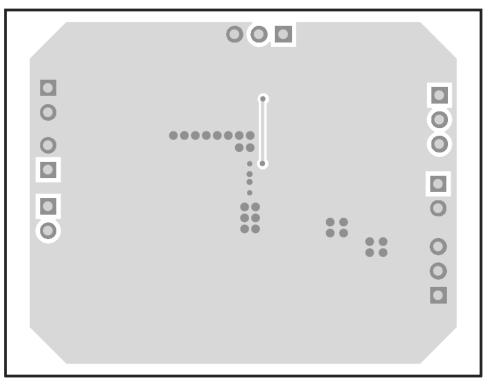
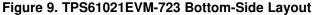


Figure 8. TPS61021EVM-723 Top-Side Layout







# **Revision History**

### NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (February 2016) to A Revision		
•	Changed device name to TPS61021A throughout document.	1

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- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

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3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

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#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

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